

## EAST Search History

| Ref # | Hits   | Search Query  | DBs   | Default Operator | Plurals | Time Stamp       |
|-------|--------|---|---|------------------|---------|------------------|
| L1    | 486390 | (connector substrate carrier board pcb) with (cavity opening groove)                  | US-PGPUB;<br>USPAT;<br>USOCR;<br>EPO; JPO;<br>DERWENT;<br>IBM_TDB | OR               | ON      | 2006/07/06 19:35 |
| L2    | 84340  | (chip die dice semiconductor ic (integrated adj circuit) component electronic) with 1 | US-PGPUB;<br>USPAT;<br>USOCR;<br>EPO; JPO;<br>DERWENT;<br>IBM_TDB | OR               | ON      | 2006/07/06 19:36 |
| L3    | 25021  | (contact terminal electrode pad tab) with 2   | US-PGPUB;<br>USPAT;<br>USOCR;<br>EPO; JPO;<br>DERWENT;<br>IBM_TDB | OR               | ON      | 2006/07/06 19:38 |
| L4    | 4161   | (lead leadframe trace pin conductor) with 3   | US-PGPUB;<br>USPAT;<br>USOCR;<br>EPO; JPO;<br>DERWENT;<br>IBM_TDB | OR               | ON      | 2006/07/06 19:39 |
| L5    | 781    | (card mobil telephone phone digital) and 4  | US-PGPUB;<br>USPAT;<br>USOCR;<br>EPO; JPO;<br>DERWENT;<br>IBM_TDB | OR               | ON      | 2006/07/06 19:40 |
| L6    | 1137   | (decoupl\$4 capacit\$4) and 4   | US-PGPUB;<br>USPAT;<br>USOCR;<br>EPO; JPO;<br>DERWENT;<br>IBM_TDB | OR               | ON      | 2006/07/06 19:41 |
| L7    | 309    | 5 and 6   | US-PGPUB;<br>USPAT;<br>USOCR;<br>EPO; JPO;<br>DERWENT;<br>IBM_TDB | OR               | ON      | 2006/07/06 19:41 |